☐ MN101C62D, MN101C62F

Туре	MN101C62D [ES (Engineering Sample) available]	MN101C62F (under development)
ROM (×8-bit)	64 K	96 K
RAM (×8-bit)	2 К	4 K
Package	LQFP080-P-1414	4A *Lead-free
Minimum Instruction Execution Time	Standard: 0.10 μs (at 4.5 V to 5.5 V, 20 MHz) 0.25 μs (at 2.7 V to 5.5 V, 8 MHz) 1.00 μs (at 2.0 V to 5.5 V, 2 MHz)* 125 μs (at 2.0 V to 5.5 V, 32 kHz)*	ble speed: 0.125 μs (at 4.5 V to 5.5 V, 8 MHz) 0.25 μs (at 3.0 V to 5.5 V, 4 MHz) 62.5 μs (at 2.0 V to 5.5 V, 32 kHz)*
	* The lower limit for operation guarantee for flash memo	
Interrupts	 Watchdog • External 0 • External 1 • External 2 • External 3 • External 3 • Timer 3 • Timer 4 • Timer 6 • Time base • Timer 7 (2 systems) • Timer 3 • Timer 4 • Timer 6 • Time base • Timer 7 (2 systems) • Timer 3 • Timer 4 • Timer 6 • Timer base • Timer 7 (2 systems) • Timer 7 (2 systems) • Serial 1 (2 systems) • Serial 2 • A/D convertible. 	imer 8 (2 systems) • Automatic transfer completion
Timer Counter		k frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation XI oscillation clock frequency; external clock input
	Timer counter 1: 8-bit × 1 (square-wave output, event co Clock source	k frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC ency; 1/1 of XI oscillation clock frequency; external
	Timer counter 0, 1 can be cascade-connected.	
	time, serial baud rate timer) Clock source	vent, simple pulse width measurement, generation of real k frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation XI oscillation clock frequency; external clock input are register 2
	Timer counter 3: 8-bit × 1 (square-wave output, event count, generation of remote Clock source	control carrier, serial baud rate timer) k frequency; 1/1, 1/4, 1/16, 1/64, 1/128 of OSC ency; 1/1 of XI oscillation clock frequency; external
	Timer counter 2, 3 can be cascade-connected.	
		k frequency; 1/1, 1/4, 1/16, 1/32, 1/64 of OSC oscillation XI oscillation clock frequency; external clock input
		quency; 1/1, 1/128, 1/8192 of OSC oscillation clock 1/8192 of XI oscillation clock frequency are register 6

Timer Counter (Continue)

Timer counter 7: 16-bit \times 1

(square-wave output, 16-bit PWM output (cycle / duty continuous variable), event count, synchronous output evevt, pulse width measurement, input capture, generation of real time)

Interrupt source coincidence with compare register 7 (2 lines)

Watchdog timer

Timer counter 8:16-bit $\times 1$

(square-wave output, 16-bit PWM output (cycle / duty continuous variable), event count, synchronous output evevt, pulse width measurement, input capture, generation of real time)

Interrupt source coincidence with compare register 7 (2 lines)

Watchdog timer

Interrupt source ----- 1/65536, 1/262144, 1/1048576 of system clock frequency

Serial Interface

Serial 0 : synchronous type/UART (full-duplex) × 1

Serial 1: synchronous type/UART (full-duplex) × 1

 $Clock\ source • \cdots • 1/2,\ 1/4\ of\ system\ clock\ frequency;\ pulse\ output\ of\ timer\ counter\ 2\ or\ 3;$

1/2,1/8 of timer counter 2 output;

1/2, 1/4, 1/16, 1/64 of OSC oscillation clock frequency

Serial 2 : synchronous type / single-master I²C

Clock source ------ 1/2, 1/4 of system clock frequency; pulse output of timer counter 2 or 3; 1/2, 1/4, 1/8, 1/32 of OSC oscillation clock frequency

I/O Pins	I/O	68	• Common use • Specified pull-up resistor available • Input/output selectable (bit uni	nit)
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A/D Inputs 10-bit \times 8-ch. (with S/H)

To bit x o cii. (with b/1

Special Ports Buzzer output, remote control carrier signal output, high-current drive port

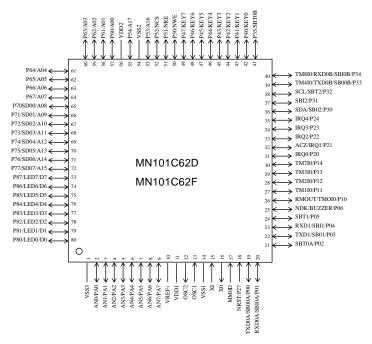
Electrical Characteristics

Supply current

Parameter	Symbol	I Condition		Limit		
r al allietei	Symbol			typ	max	Unit
Operating cumply current	IDD1	fosc = 20 MHz, VDD = 5 V		18	30	mA
Operatingsupplycurrent	IDD2	fx = 32 kHz, VDD = 3 V		30	60	μА
Supply current at HALT	IDD3	fx = 32 kHz, VDD = 3 V, Ta = 25°C		6	8	μА
	fx = 32 kHz, VDD = 3 V, Ta = 85°C			30	μА	
Supply current at STOP	IDD5	VDD = 5 V, Ta = 25°C			2	μА
- Supply Current at STOP	IDD6	VDD = 5 V, Ta = 85°C			50	μА

See the next page for pin assignment and support tool.

Pin Assignment



LQFP080-P-1414A *Lead-free

Support Tool

In-circuit Emulator	PX-ICE101C / D + PX-PRB101C62-LQFP080-P-1414A-M (under development)		
Flash Memory Built-in Type	Туре	MN101CF62G (under development)	
	ROM (× 8-bit)	128 K	
	RAM (× 8-bit)	10 K	
	Minimum instruction execution time	0.1 μs (at 4.5 V to 5.5 V, 20 MHz)	
		$0.25~\mu s$ (at $3.0V$ to $5.5~V, 8~MHz)$	
		$62.5~\mu s$ (at $3.0~V$ to $5.5~V,32~kHz)$	
	Package	LQFP080-P-1414A *Lead-free	

MN101C62D , MN101C62F \square

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